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Number: TIDA-00302	Rev: A	Designed for: Public Release	Mod. Date: 3/18/2015
SVN Rev. Version control disabled	Assembly Variant: 001	Project Title: TIDA-00302 Transient Robustness	Sheet Title: Schematic
Drawn By: Jamieson Wardall	File: BlankSheet_ANSI-B_SchDoc	Sheet: 1 of 2	Size: B
Engineer: Enter name of project lead	Contact: <a href="http://www.ti.com/support">http://www.ti.com/support</a>		

H1 NY PMS 440 0025 PH H2 NY PMS 440 0025 PH H3 NY PMS 440 0025 PH H4 NY PMS 440 0025 PH

H5 1902C H6 1902C H7 1902C H8 1902C

DNP FID1 DNP FID2 DNP FID3

PCB Number: TIDA-00302  
PCB Rev: A

PCB LOGO  
Texas Instruments

LBL1  
PCB Label  
Size: 0.65" x 0.20"

ZZ1  
Label Assembly Note  
This Assembly Note is for PCB labels only

ZZ2  
Assembly Note  
These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ3  
Assembly Note  
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ4  
Assembly Note  
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

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Designed for: Public Release		Mod. Date: 3/18/2015	
Project Title: TIDA-00302 Transient Robustness			
Number: TIDA-00302	Rev: A	Sheet Title: Hardware	Sheet: 2 of 2
SVN Rev. Version control disabled		Assembly Variant: 001	Size: B
Drawn By: Jamieson Wardall	File: Hardware ANSI-B.SchDoc	http://www.ti.com	
Engineer: Enter name of project lead	Contact: http://www.ti.com/support	© Texas Instruments 2014	

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